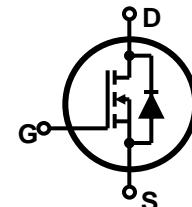
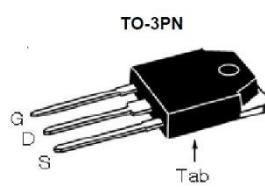


Features

- Low gate charge
- 100% avalanche tested
- Improved dv/dt capability
- RoHS compliant
- JEDEC Qualification

N-channel MOSFET		
BV_{DSS}	I_D	$R_{DS(on)MAX}$
600V	20A	<0.33Ω



Device	Package	Marking	Remark
GP1M020A060N	TO-3PN	GP1M020A060N	RoHS

Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	600	V
Gate-Source Voltage	V_{GS}	± 30	V
Continuous Drain Current $T_C = 25\text{ °C}$	I_D	20	A
		12.4	A
Pulsed Drain Current (Note 1)	I_{DM}	80	A
Single Pulse Avalanche Energy (Note 2)	E_{AS}	1330	mJ
Repetitive Avalanche Current (Note 1)	I_{AR}	20	A
Repetitive Avalanche Energy (Note 1)	E_{AR}	34.7	mJ
Power Dissipation $T_C = 25\text{ °C}$	P_D	347	W
		2.77	W/°C
Peak Diode Recovery dv/dt (Note 3)	dv/dt	4.5	V/ns
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55~150	°C
Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	T_L	300	°C

* Limited only by maximum junction temperature

Thermal Characteristics

Parameter	Symbol	Value	Unit
Maximum Thermal resistance, Junction-to-Case	$R_{\theta JC}$	0.36	°C/W
Maximum Thermal resistance, Junction-to-Ambient	$R_{\theta JA}$	62.5	°C/W

Electrical Characteristics : $T_c=25^\circ\text{C}$, unless otherwise noted

Parameter	Symbol	Test condition	Min	Typ	Max	Units
OFF						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{\text{GS}} = 0 \text{ V}, I_{\text{D}} = 250 \mu\text{A}$	600	--	--	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{\text{DS}} = 600 \text{ V}, V_{\text{GS}} = 0 \text{ V}$	--	--	1	μA
		$V_{\text{DS}} = 480 \text{ V}, T_c = 125^\circ\text{C}$	--	--	10	μA
Forward Gate-Source Leakage Current	I_{GSSF}	$V_{\text{GS}} = 30 \text{ V}, V_{\text{DS}} = 0 \text{ V}$	--	--	100	nA
Reverse Gate-Source Leakage Current	I_{GSSR}	$V_{\text{GS}} = -30 \text{ V}, V_{\text{DS}} = 0 \text{ V}$	--	--	-100	nA
ON						
Gate Threshold Voltage	$V_{\text{GS(th)}}$	$V_{\text{DS}} = V_{\text{GS}}, I_{\text{D}} = 250 \mu\text{A}$	2	--	4	V
Drain-Source On-Resistance	$R_{\text{DS(on)}}$	$V_{\text{GS}} = 10 \text{ V}, I_{\text{D}} = 10 \text{ A}$	--	0.27	0.33	Ω
Forward Transconductance ^(Note 4)	g_{FS}	$V_{\text{DS}} = 30 \text{ V}, I_{\text{D}} = 10 \text{ A}$	--	30	--	S
DYNAMIC						
Input Capacitance	C_{iss}	$V_{\text{DS}} = 25 \text{ V}, V_{\text{GS}} = 0 \text{ V}, f = 1.0 \text{ MHz}$	--	2097	--	pF
Output Capacitance	C_{oss}		--	146	--	pF
Reverse Transfer Capacitance	C_{rss}		--	14	--	pF
SWITCHING						
Turn-On Delay Time ^(Note 4,5)	$t_{\text{d(on)}}$	$V_{\text{DD}} = 300 \text{ V}, I_{\text{D}} = 20 \text{ A}, R_G = 25 \Omega$	--	73	--	ns
Turn-On Rise Time ^(Note 4,5)	t_r		--	63	--	ns
Turn-Off Delay Time ^(Note 4,5)	$t_{\text{d(off)}}$		--	384	--	ns
Turn-Off Fall Time ^(Note 4,5)	t_f		--	72	--	ns
Total Gate Charge ^(Note 4,5)	Q_g	$V_{\text{DS}} = 480 \text{ V}, I_{\text{D}} = 20 \text{ A}, V_{\text{GS}} = 10 \text{ V}$	--	76	--	nC
Gate-Source Charge ^(Note 4,5)	Q_{gs}		--	14.4	--	nC
Gate-Drain Charge ^(Note 4,5)	Q_{gd}		--	25	--	nC
SOURCE DRAIN DIODE						
Maximum Continuous Drain-Source Diode Forward Current	I_s	---	--	--	20	A
Maximum Pulsed Drain-Source Diode Forward Current	I_{SM}	---	--	--	80	A
Drain-Source Diode Forward Voltage	V_{SD}	$V_{\text{GS}} = 0 \text{ V}, I_s = 20 \text{ A}$	--	--	1.5	V
Reverse Recovery Time ^(Note 4)	t_{rr}	$V_{\text{GS}} = 0 \text{ V}, I_s = 20 \text{ A}$ $dI_F / dt = 100 \text{ A}/\mu\text{s}$	--	452	--	ns
Reverse Recovery Charge ^(Note 4)	Q_{rr}		--	5.9	--	μC

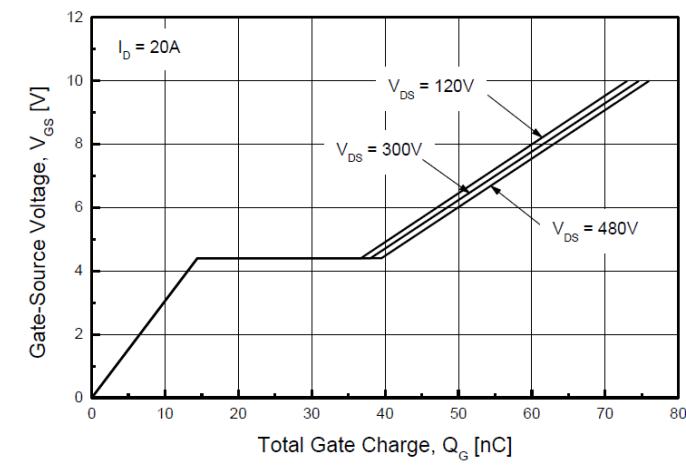
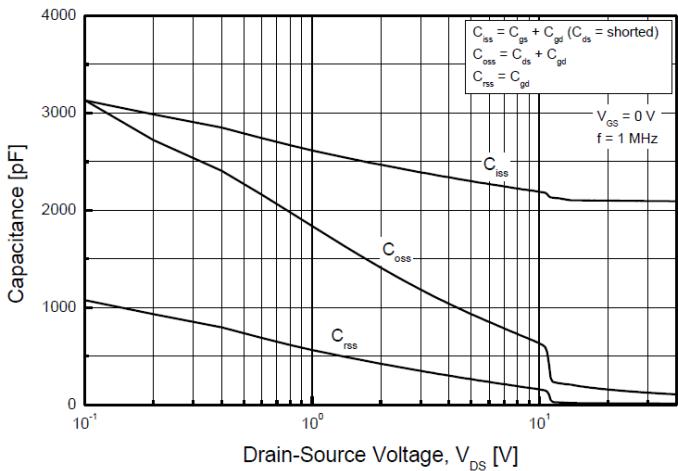
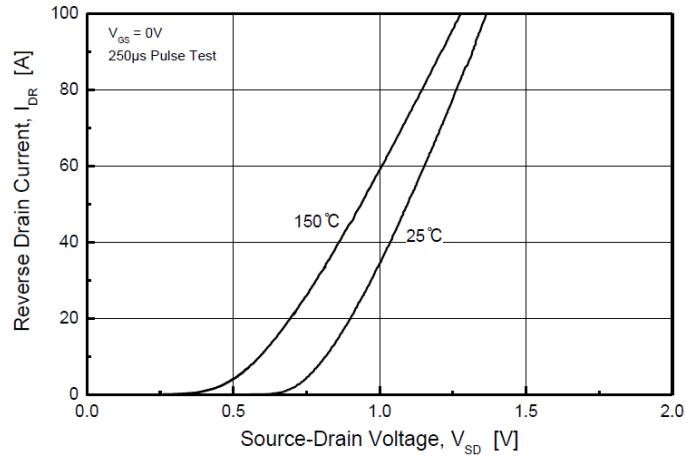
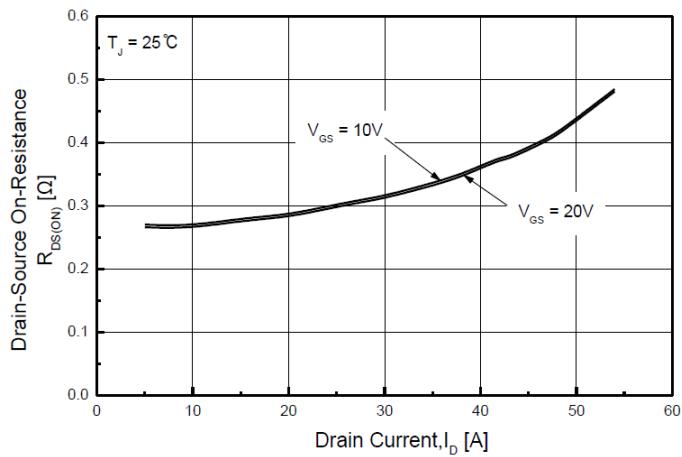
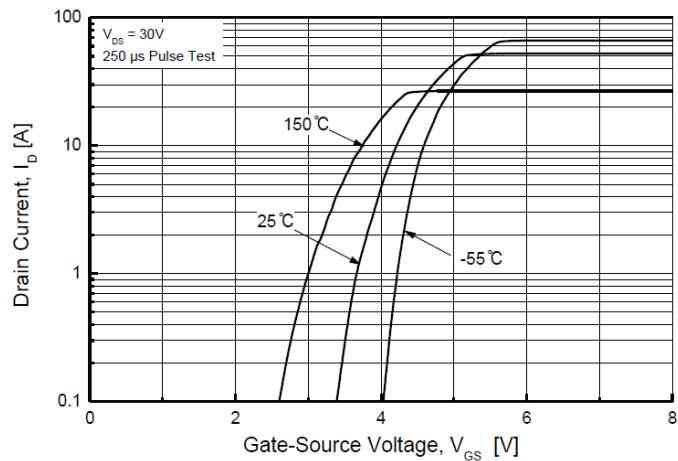
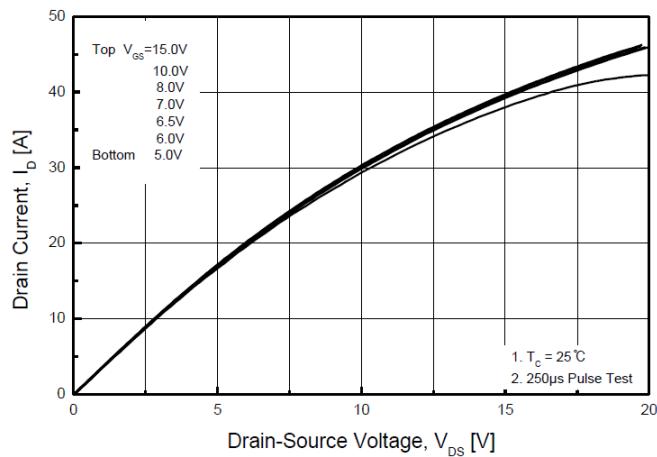
Note :

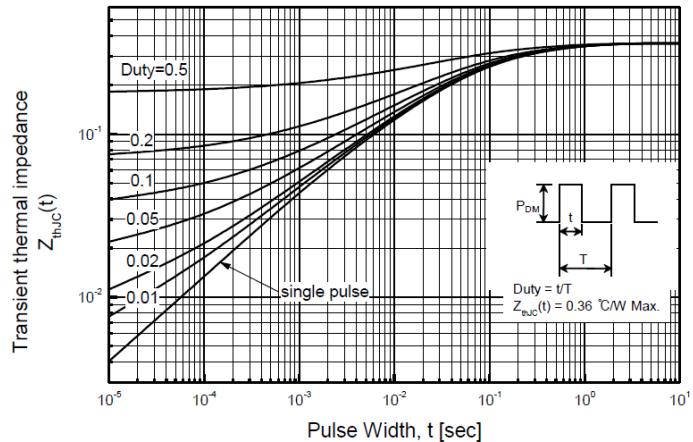
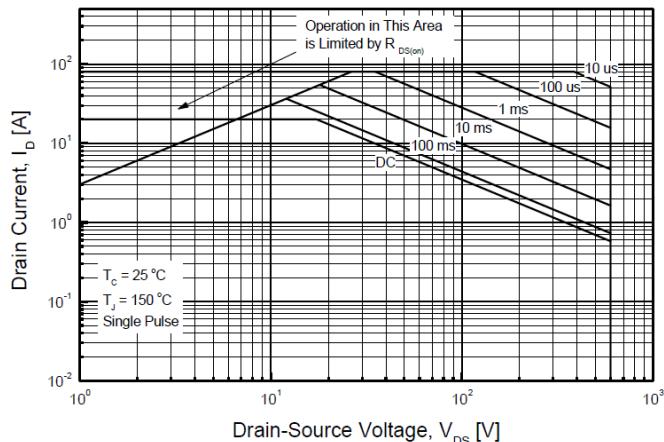
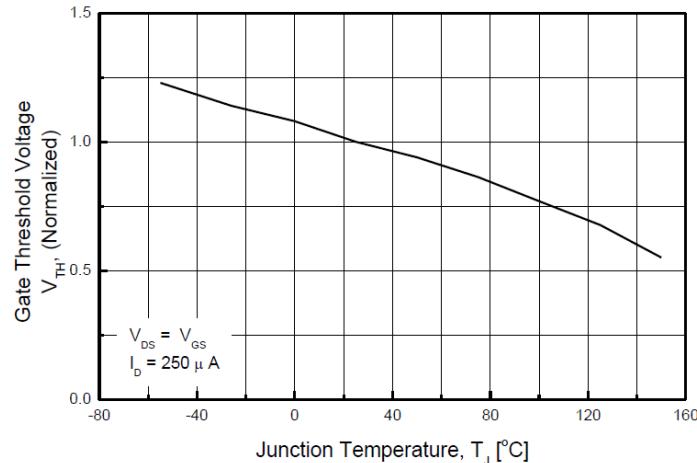
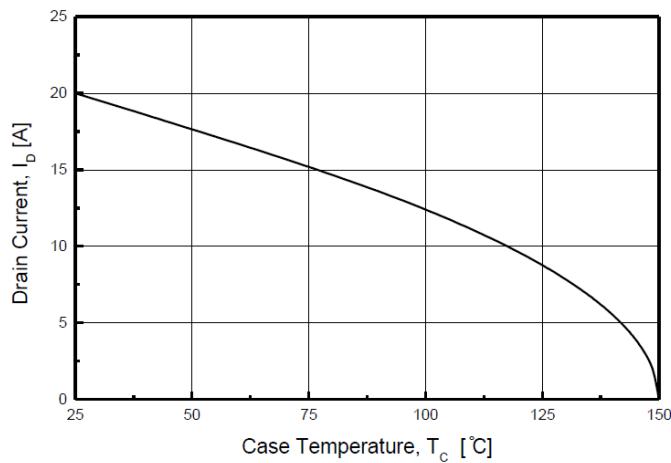
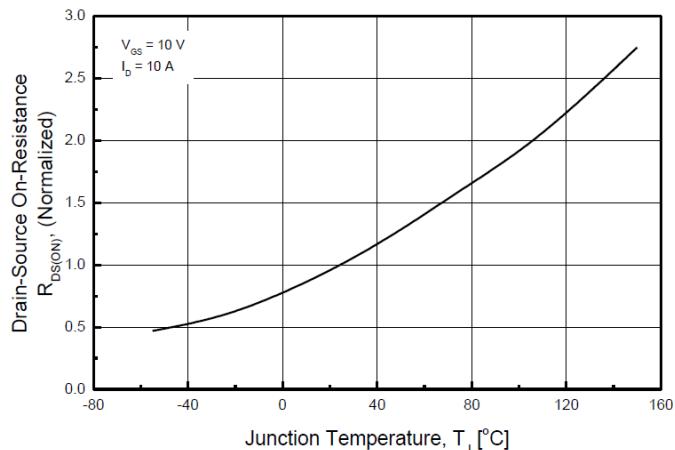
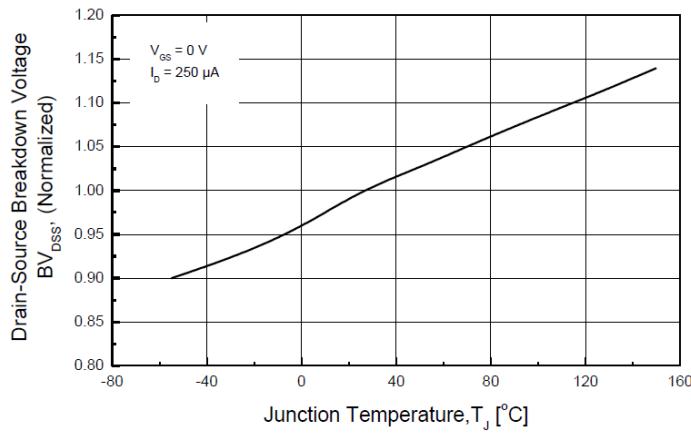
1. Repeated rating : Pulse width limited by safe operating area
2. $L=6.1\text{mH}$, $I_{AS} = 20\text{A}$, $V_{DD} = 50\text{V}$, $R_G = 25\Omega$, Starting $T_J = 25^\circ\text{C}$

3. $I_{SD} \leq 20\text{A}$, $di/dt \leq 200\text{A}/\mu\text{s}$, $V_{DD} \leq \text{BV}_{DS}$, Starting $T_J = 25^\circ\text{C}$

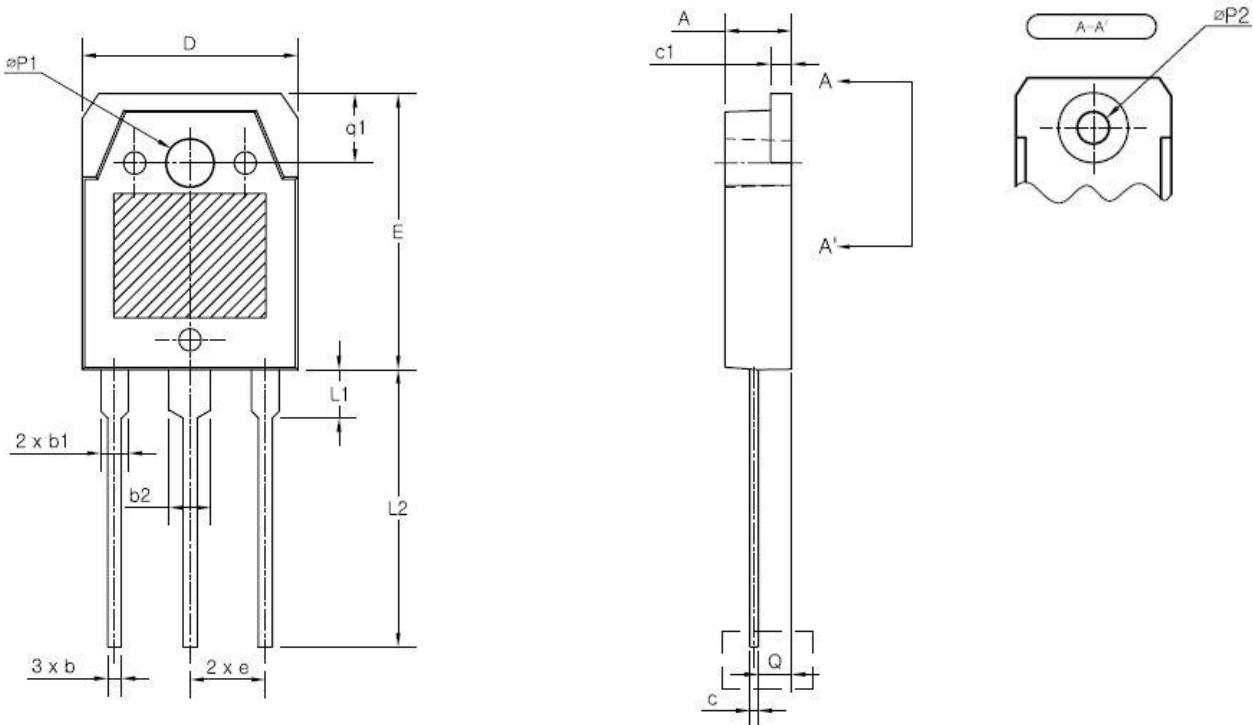
4. Pulse Test : Pulse width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$

5. Essentially Independent of Operating Temperature Typical Characteristics





TO-3PN MECHANICAL DATA



SYMBOL	MIN	NOM	MAX
A	4.60	4.80	5.00
b	0.80	1.00	1.20
b1	1.80	2.00	2.20
b2	2.80	3.00	3.20
c	0.55	0.60	0.75
c1	1.45	1.50	1.65
D	15.40	15.60	15.80
E	19.70	19.90	20.10
e	5.15	5.45	5.75
L1	3.30	3.50	3.70
L2	19.80	20.00	20.20
øP1	3.30	3.40	3.50
øP2		(3.20)	
Q	2.20	2.40	2.60
q1	4.80	5.00	5.20

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